

Call for Papers
a Session on

Cutting and Machine Tools

2016 ASME/ISCIE International Symposium on Flexible Automation (ISFA2016)
InterContinental Hotel & Conference Center
August 1-3, 2016, Cleveland, Ohio, USA

Session Technical Focus

Cutting, though being studied for centuries, is still evolving with the new functional requirement and technological advancement in advanced materials, precision machine tools, etc. The new challenges to high performance cutting is not only restricted to the traditional attributes such as dimensional accuracy, but also including much broader aspects such as functional competency, new-material processing capabilities, energy consumption. These challenges are being addressed through constant development of new concepts and deeper understandings of the cutting process and advances in the precision machine tool designs. We cordially invite you to submit a paper to share your knowledge and expertise in all areas related to **Cutting and Machine Tools**. Papers from the industrial sector are particularly encouraged. The session welcomes both theoretical and applied papers in areas including, but not limited to:

- Simulation and theoretical studies of the cutting process
- Non-traditional cutting processes (vibration-assisted, laser-assisted, etc.)
- Automation and control of the cutting process
- Precision machine tools and components
- High performance cutting
- Micro-scale cutting

Paper Submission

The deadline for submission of your contribution to this session is **February 29, 2016**. Both short and long papers will be considered and reviewed. For short papers, please submit a summary of 1,000 words or less (short papers will be limited to 4 pages) and, for long papers, please submit a manuscript of no more than eight pages. All summaries and manuscripts should be submitted through the conference website at <http://engineering.case.edu/conference/ISFA2016/>.

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